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**Part Number:** [73944-7217](#)  
**Status:** **Active**  
**Overview:** HDM®  
**Description:** 2.00mm Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Solder Tail, Guide Pin Option, 144 Circuits

**Documents:**

[3D Model](#) [Product Specification PS-73670-9999 \(PDF\)](#)  
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

**Agency Certification**

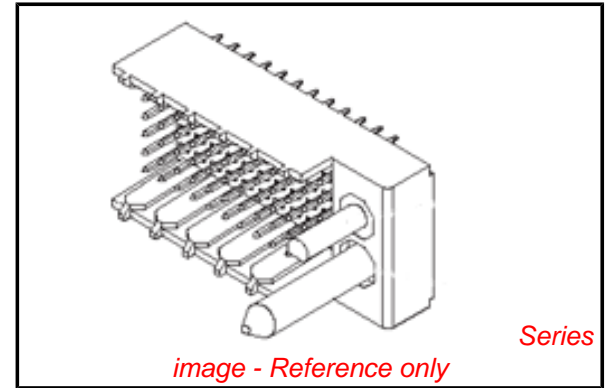
CSA LR19980  
 UL E29179

**General**

Product Family Backplane Connectors  
 Series [73944](#)  
 Application Backplane  
 Component Type PCB Header  
 Overview [HDM®](#)  
 Product Name HDM®  
 Style N/A  
 UPC 800754876568

**Physical**

Circuits (Loaded) 144  
 Circuits (maximum) 144  
 Color - Resin Black, Natural  
 Durability (mating cycles max) 250  
 First Mate / Last Break No  
 Flammability 94V-0  
 Guide to Mating Part Yes  
 Keying to Mating Part Yes  
 Material - Metal Phosphor Bronze, Stainless Steel  
 Material - Plating Mating Gold  
 Material - Plating Termination Tin  
 Material - Resin High Temperature Thermoplastic  
 Net Weight 8.594/g  
 Number of Columns 24  
 Number of Pairs Open Pin Field  
 Number of Rows 6  
 Orientation Vertical  
 PC Tail Length 3.50mm  
 PCB Locator Yes  
 PCB Retention None  
 PCB Thickness - Recommended 2.50mm  
 Packaging Type Tube  
 Pitch - Mating Interface 2.00mm  
 Pitch - Termination Interface 2.00mm  
 Plating min - Mating 0.762µm  
 Plating min - Termination 2.540µm  
 Polarized to PCB No  
 Stackable No  
 Surface Mount Compatible (SMC) No  
 Temperature Range - Operating -55°C to +105°C  
 Termination Interface: Style Through Hole



**EU RoHS**

**ELV and RoHS Compliant**  
**REACH SVHC Contains SVHC: No**  
**Low-Halogen Status Low-Halogen**

**China RoHS**



**Need more information on product environmental compliance?**

Email [productcompliance@molex.com](mailto:productcompliance@molex.com)  
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

**Search Parts in this Series**

[73944Series](#)

**Mates With**

73632 HDM PLUS® Board-to-Board Daughtercard Receptacle. 73780 HDM® Board-to-Board Daughtercard Receptacle

**Application Tooling | FAQ**

*Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.*

**Global**

| Description         | Product #                  |
|---------------------|----------------------------|
| Extraction Tool     | <a href="#">0621001000</a> |
| Backplane Insertion | <a href="#">0621001400</a> |
| Signal Contact Tool |                            |

**Electrical**

|                               |          |
|-------------------------------|----------|
| Current - Maximum per Contact | 1A       |
| Data Rate                     | 1.0 Gbps |
| Shielded                      | No       |
| Voltage - Maximum             | 250V AC  |

**Solder Process Data**

|  |                              |
|--|------------------------------|
| Duration at Max. Process Temperature (seconds) | 40                           |
| Lead-free Process Capability                   | SMC & Wave Capable (TH only) |
| Max. Cycles at Max. Process Temperature        | 3                            |
| Process Temperature max. C                     | 260                          |

**Material Info****Reference - Drawing Numbers**

|                       |               |
|-----------------------|---------------|
| Product Specification | PS-73670-9999 |
| Sales Drawing         | SD-73944-001  |

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